## AMENDMENTS TO THE CLAIMS

Please amend the claim set as indicated below:

Claims 1-17. (cancelled)

18. (currently amended) A process for manufacturing a metal-infiltrated powder metal part, the process comprising: compacting a powder metal to form a compact;

sintering the compact at a temperature sufficient to form a sintered compact with a matrix having pores;

forming an infiltrant blank from a wrought metal sheet, the blank having a locating element that is suitable for engaging a corresponding locating element on the <u>sintered</u>-compact;

placing the infiltrant blank in contact with the sintered compact such that the locating element of the blank engages the corresponding locating element on the sintered compact, the engagement of the locating element of the infiltrant blank and the corresponding locating element of the compact restricting movement of the infiltrant blank relative to the compact; and

melting the wrought metal such that the melted wrought metal infiltrates the pores of the sintered-compact.

19. (original) The process of claim 18 wherein: the powder metal is selected from iron, iron alloys and mixtures thereof; and

the wrought metal is selected from copper and copper alloys.

20. (original) The process of claim 19 wherein: the wrought metal sheet has a thickness of less than 1 millimeter.

- 21. (original) The process of claim 18 wherein: the infiltrant blank is formed by a method selected from stamping, fine blanking and laser cutting.
- 22. (original) The process of claim 18 wherein: the locating element of the blank is a section of the blank extending outwardly from a body of the blank.
- 23. (new) The process of claim 18 wherein: the steps of sintering and infiltrating occur simultaneously.
- 24. (new) The process of claim 18 wherein: the step of sintering occurs separately and before the step of infiltrating.
- 25. (new) The process of claim 18 wherein:
  the step of placing the infiltrant blank in contact with
  the compact includes placing the infiltrant blank on a top outer
  surface of the compact.
- 26. (new) The process of claim 18 wherein:
  the locating element of the infiltrant blank has an edge
  surface that is configured to selectively contact a wall of the
  compact.